

Ultrasonic Characterization of Explosively-Bonded Concentric Tubes

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Presentation Outline

- Background
- Purpose
- Machining
- Microscopy
- Ultrasound techniques
- Conclusions
- Future work

Background

- Concentric tubes used in military applications
- Wear resistance liner (donor tube)
- Tubes bonded explosively
- Many factors in process, affect bond quality
- Ends of composite tube are scrapped
- Bond quality difficult to ascertain

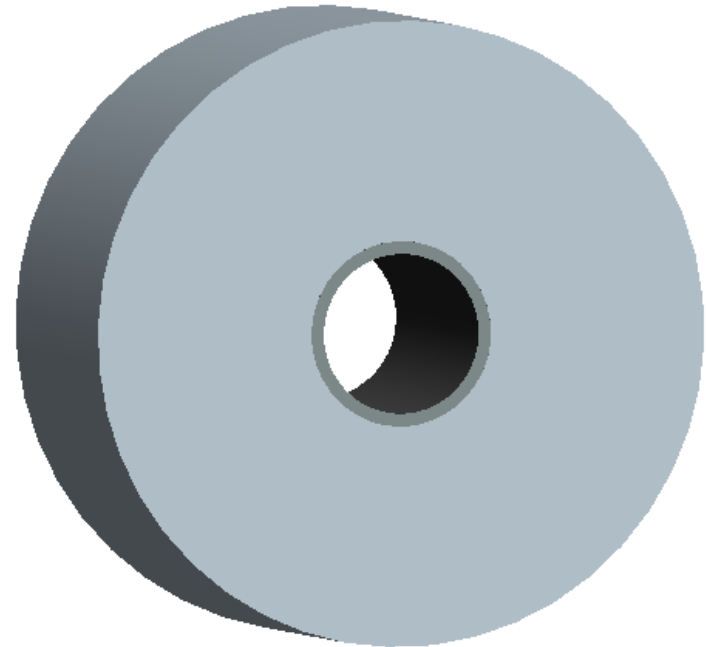
Aim

- Find inspection method for material interface
- Non-Destructive Test (NDT) is preferred
- Assess overall bond quality
- Serve as QC or life monitoring tool
- Correlate NDT and destructive methods

EB Specimen

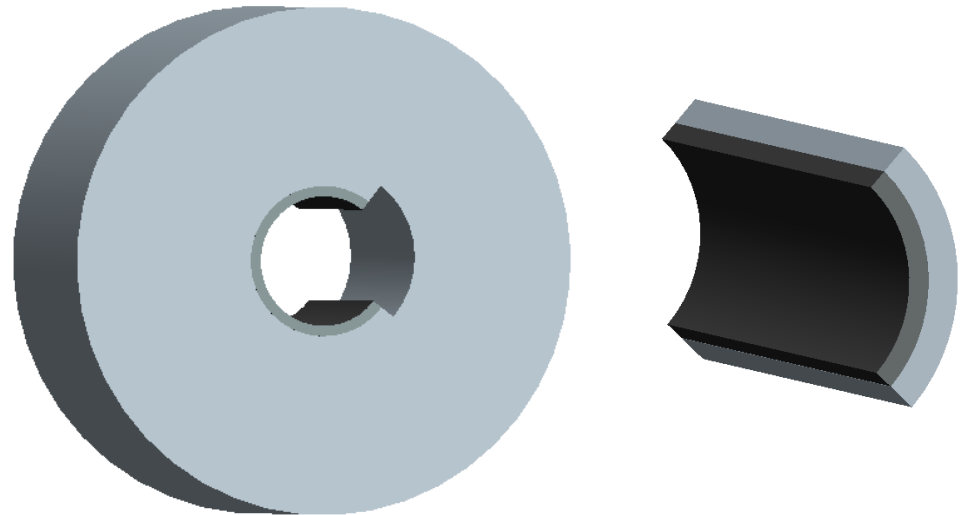
- Steel major tube
- Alloy donor tube
- ~ 3" length
- ~ 4" OD, 1" ID

- 1 "poor" - PEBS
- 1 "good" - GEBS



Machining

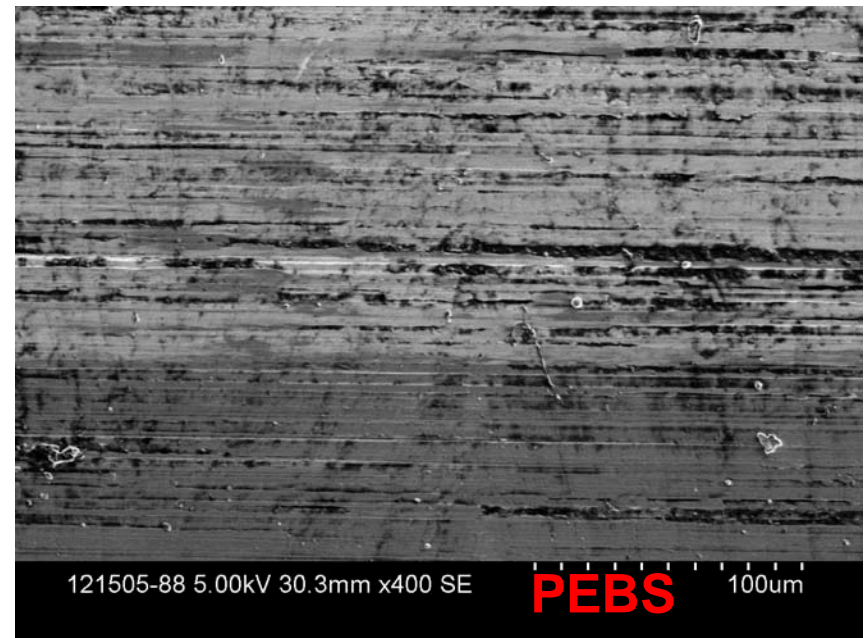
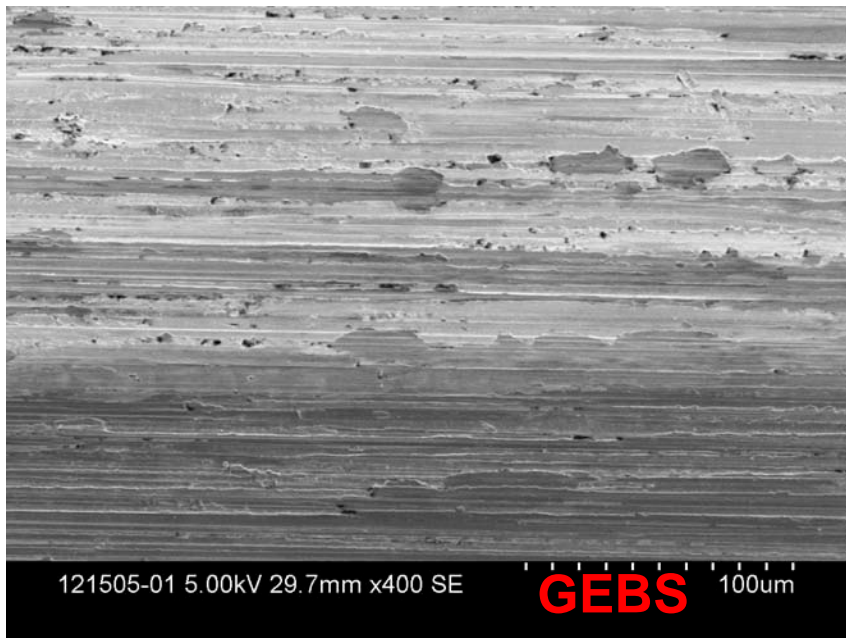
- EDM samples
 - Destructive tests
 - Microscopy
 - Hardness tests
 - Alloy analysis



Microscopy

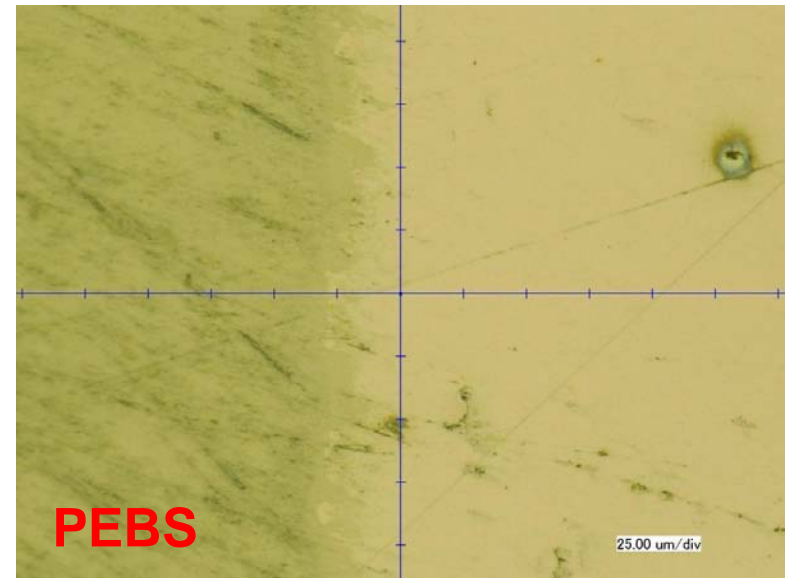
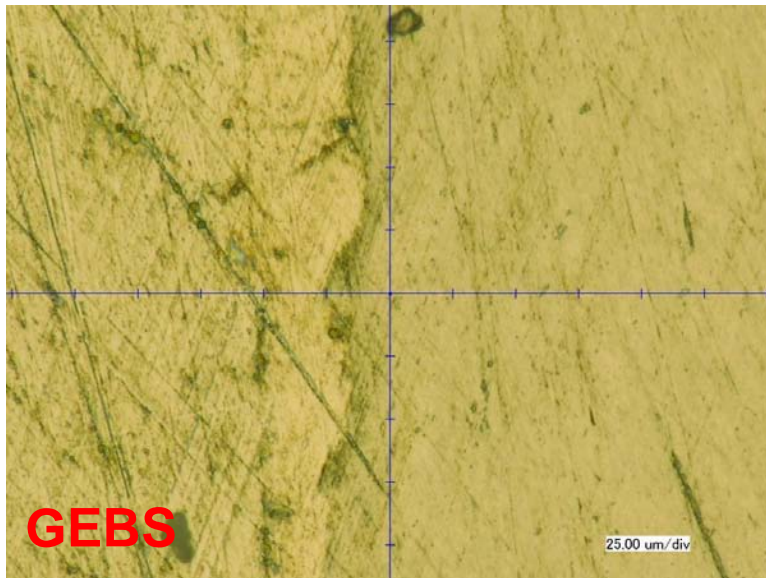
- SEM

- Destructive, time consuming, small sampling area
- Looking for “wavy interface” and “material mixing”



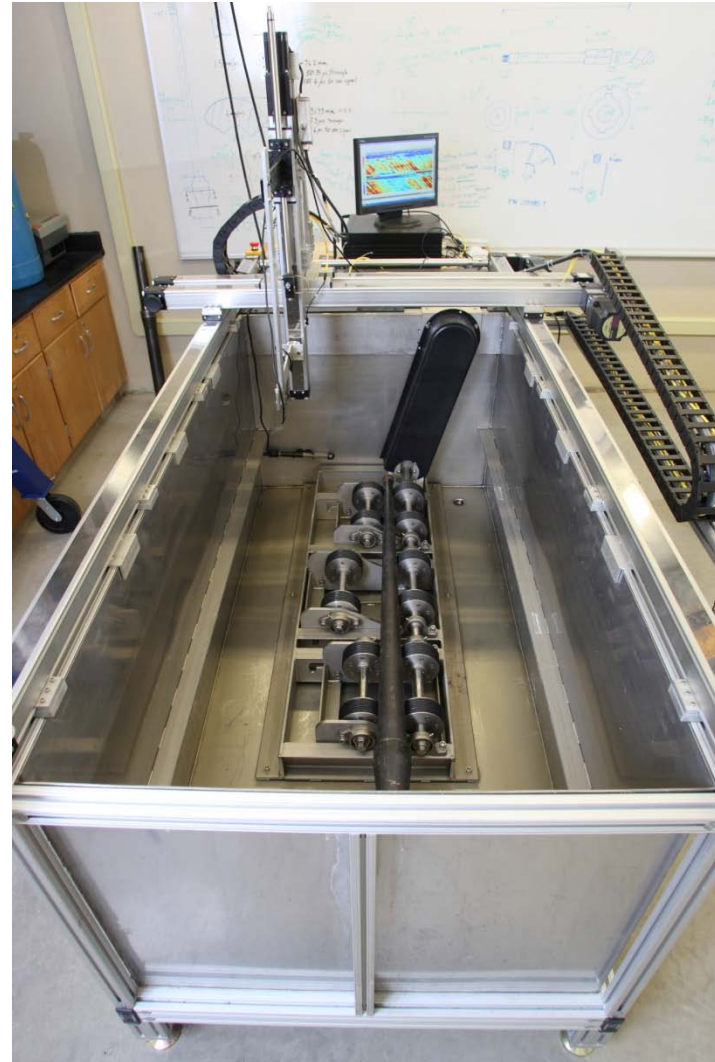
Microscopy

- Digital Microscope
 - Quick, little preparation, color

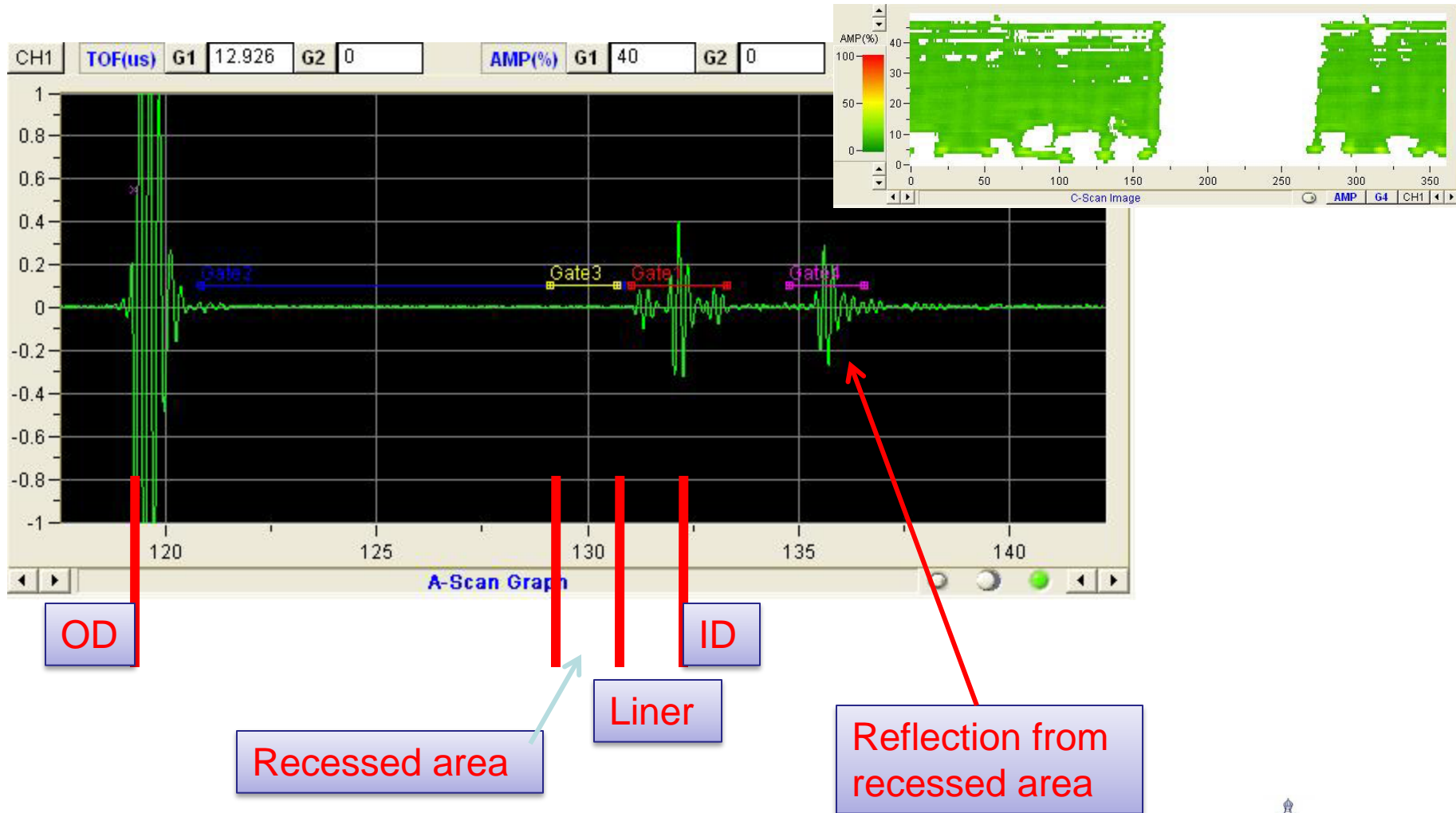


Ultrasonic Methods

- Physical Acoustics
 - Immersion Scanner
- Resolution 0.0001"
- Max 20 in/sec
- 2,000 lbs max load
- 3-10" diameter tubes
- Up to 5' length

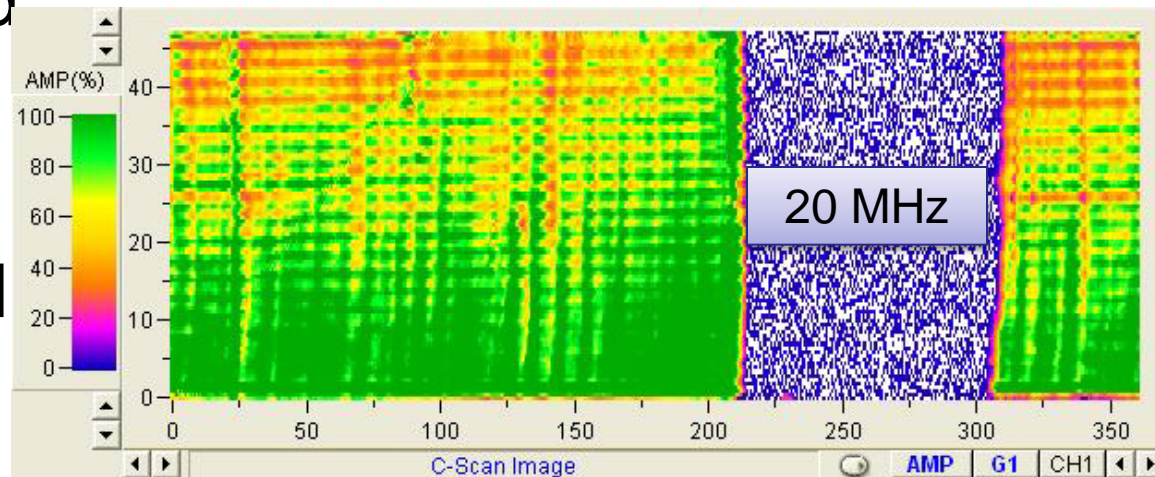
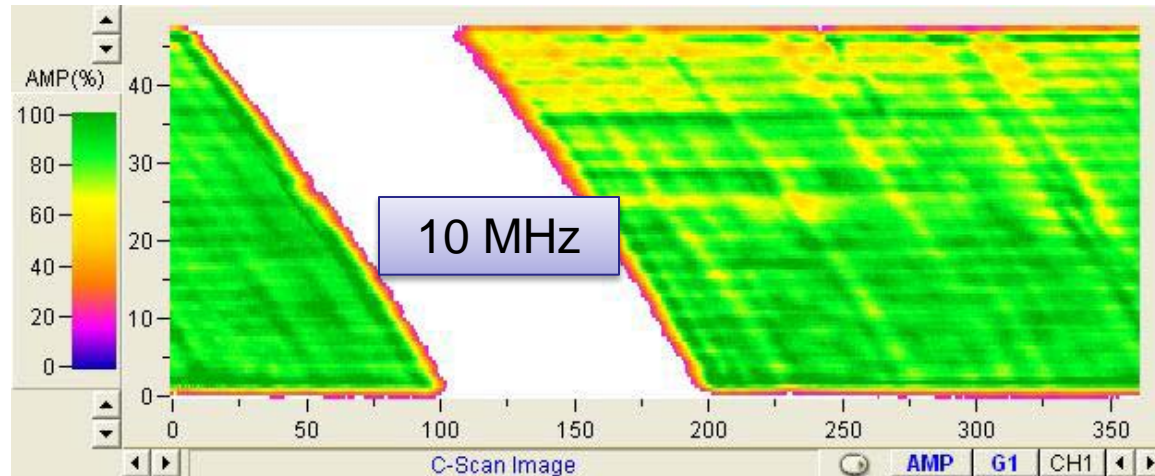


Bond Focusing



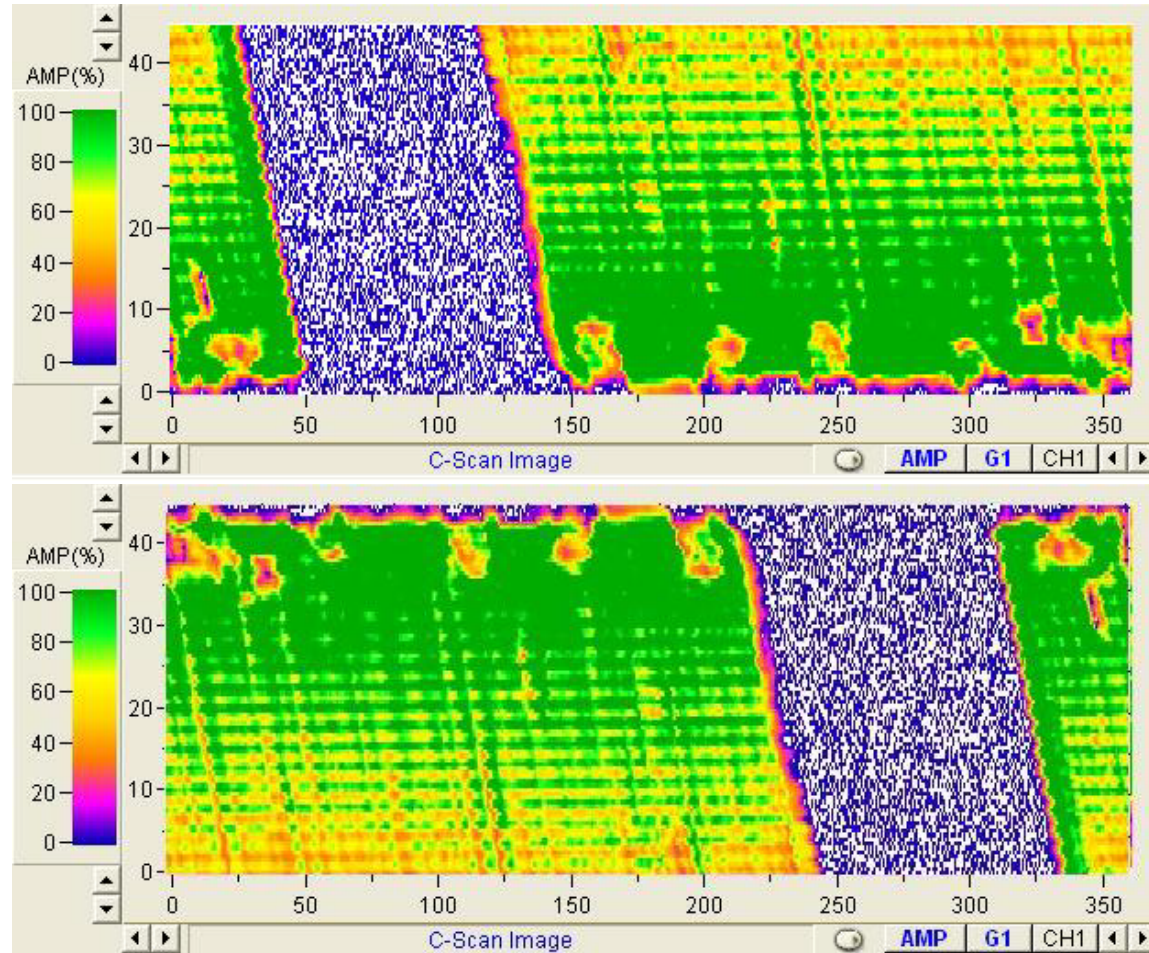
Frequency Optimization

- High frequency
 - Inc. resolution
 - Same settings
- 20 MHz selected
 - On hand
- Gap = Removed
- Slant = Tuning



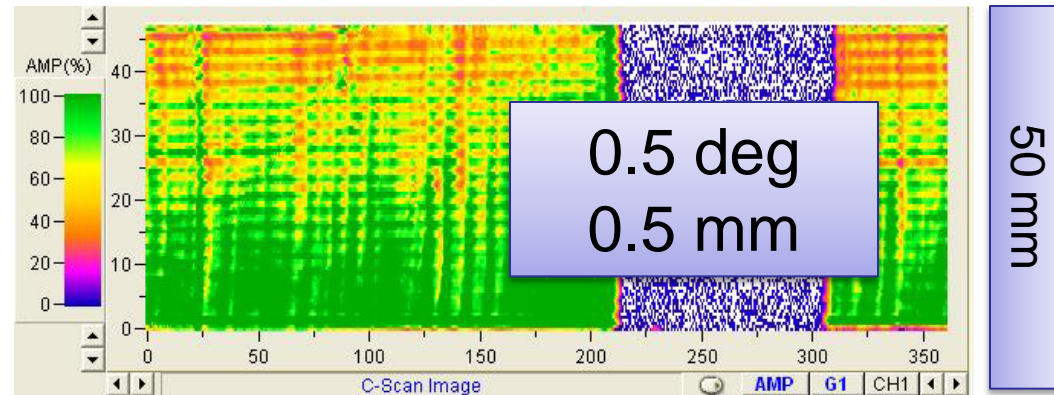
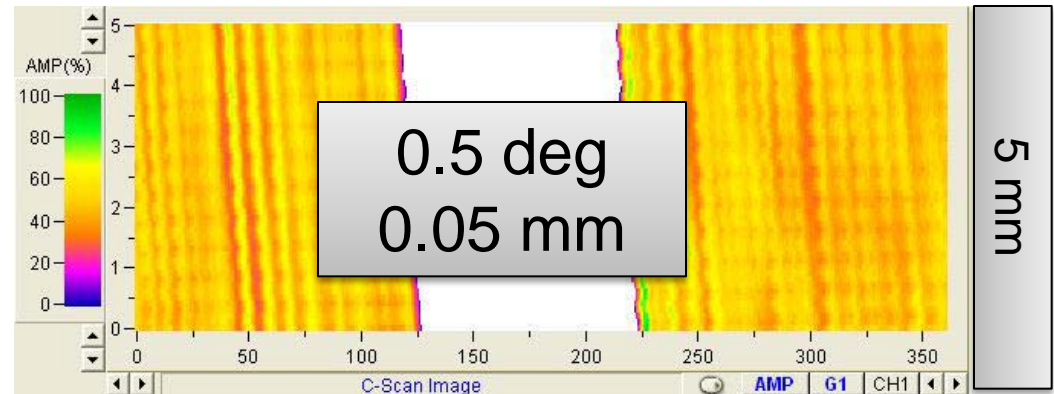
Gradient

- Caused by ?
 - Δ bond
 - Scan method
- Reversed part
 - Same scan
 - Same trend
- Δ bond is cause
- Less obvious GEBS



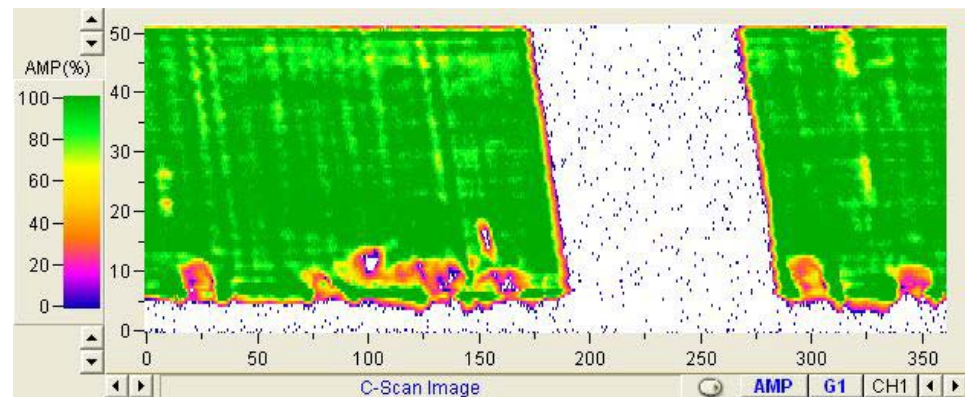
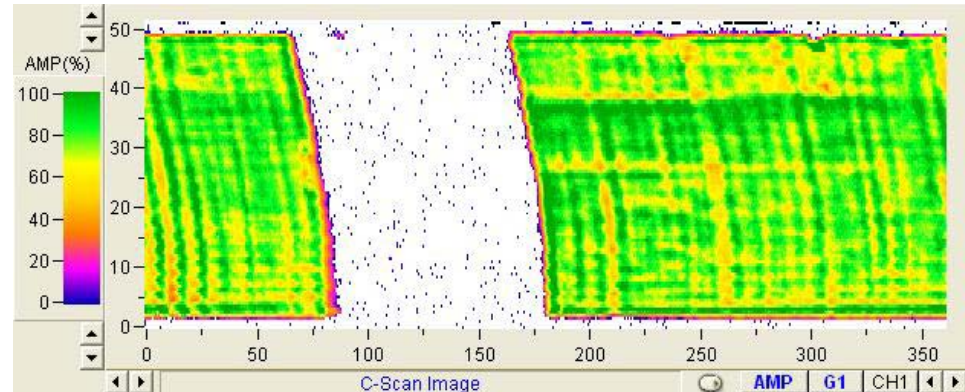
Stripes

- Caused by ?
 - Wavy axial bond
 - Scan method
- Changed step size
 - Same results
- Scan method



Good vs. Poor

- GEBS
 - Lower reflection amp.
- PEBS
 - Higher reflection amp.
- Good bond provides easier transmission of acoustic energy

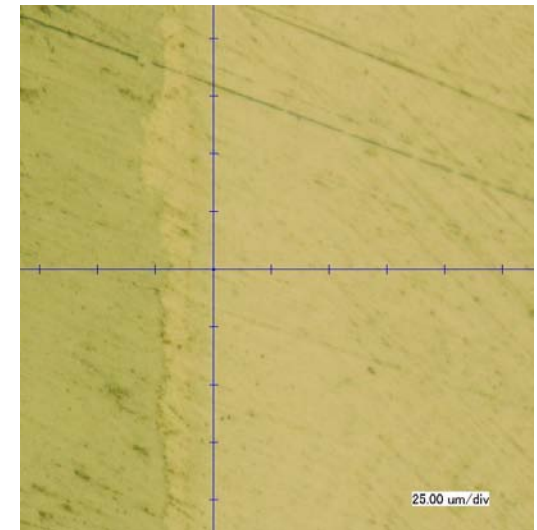
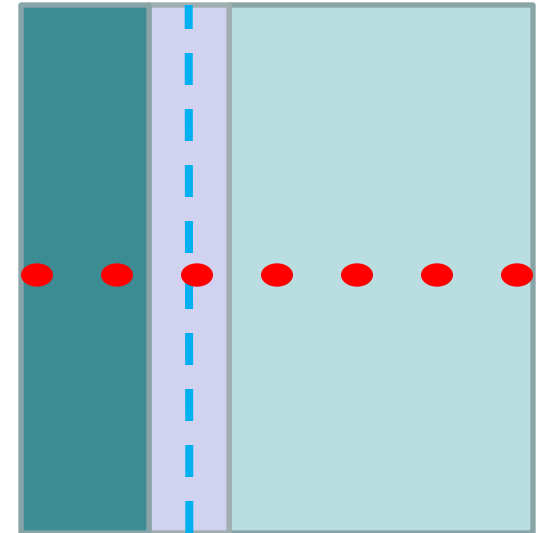


Conclusions

- Semi-Quantitative
 - Need reference tube as standard
- Poor vs. Good Distinguishable
- Observed Gradient Due to bond
- Frequency Effects Higher (20MHz) is Better
- Stripes Due to scan method

Future Work

- Reference specimen
- Hardness vs. alloy composition
 - Micro hardness tester
 - Alloy analyzer
- Correlate to NDT-UT & destructive results



Questions?

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